

Appl. No. 09/881,299



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. 09/881,299
Filing Date June 13, 2001
Inventor Dinesh Chopra, et al
Assignee Micron Technology, Inc.
Group Art Unit 2814
Examiner P. Cao
Attorney's Docket No. MI22-1747
Title: Conductive Connection Forming Methods, Oxidation Reducing Methods, and
Integrated Circuits Formed Thereby

#6/a
5/9/02
✓/hwt

RESPONSE TO JANUARY 3, 2002 OFFICE ACTION

To: Box Fee amendment
Attn: Art Unit 2814
Assistant Commissioner for Patents
Washington, D.C. 20231

From: James E. Lake (Tel. 509-624-4276; Fax 509-838-3424)
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AMENDMENTS

In the Claims

Please replace the claims 47, 48, and 52 with the following clean version of the amended claims and add new claims 55-59, in accordance with 37 C.F.R. § 1.121(c)(1)(i).
Cancel all previous versions of any amended claim.

A marked up version showing amendments to any claims being changed is provided in one or more accompanying pages separate from this amendment in accordance with 37

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